ABB Switzerland Ltd.
Via Luserte Sud 9
6572 Quartino
Switzerland

PHONE DIRECT +4191 850 29 29
FAX DIRECT +41 91 840 12 54

Subject: RoHS II Declaration

Quartino, October 10th, 2025

To whom it may concern:

On January 3rd 2013, Directive 2011/65/EU (RoHS 11) on the restriction of the use of certain hazardous substances in electrical and electronic equipment replaced Directive 2002/95/EC (RoHS).

According to our current best knowledge and according to the information provided by suppliers, ABB Uninterruptible Power Supply Equipment and accessories comply with substances re- strictions in Directive 2011/65/EU (RoHS II) and Amendment Directive (EU) 2015/863.

All information concerning RoHS exemptions are reported on the following page.

Doc. Number	**Date**	**Marco Piemontesi**	**Carlo Bassi**
4NWD005610 REV. A	10.10.2025	Chapter Lead, Electronics HW	Local Product Group Manager

Marco Piemontesi
Marco Piemontesi (Oct 10, 2025 14:11:32 GMT+2)

Carlo Bassi

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RoHS EXEMPTIONS UPS

6(a)-I - Lead as an alloying element in steel for machining purposes containing up to 0.35% lead by weight and in batch hot dip galvanised steel components containing up to 0.2% lead by weight

-Certain fasteners

6(b) - Lead as an alloying element in aluminium containing up to 0.4% lead by weight

-Certain fuses

6(c) - Copper alloy containing up to 4% lead by weight

-Certain fuses

-brass made fasteners mounted over panels or over capacitors

7(a) - Lead in high melting temperature type solders (i.e. lead- based alloys containing 85 % by weight or more lead)

-Certain electronic diodes or semiconductors mounted mounted on printed circuit boards

-Certain fuses

-Certain heatsink mounted semiconductors

7(c)-I - Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g. piezoelectronic devices, or in a glass or ceramic matrix compound

-Certain electronic components mounted mounted on printed circuit boards

-Certain heatsink mounted semiconductors

7(c)-II - Lead in dielectric ceramic in capacitors for a rated voltage of 125 V AC or 250 V DC or higher

-Certain SMD capacitors mounted over printed circuit boards

15 - Lead in solders to complete a viable electrical connection between semiconductor die and carrier within integrated circuit flip chip packages

-Certain IGBT welds

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